

V_{DSS}	600V
$R_{DS(on)}(Max.)$	0.130Ω
I_D	±30A
P_D	86W

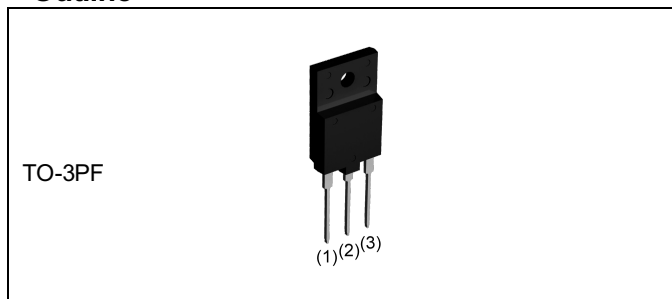
●Features

- 1) Low on-resistance.
- 2) Ultra fast switching speed.
- 3) Parallel use is easy.
- 4) Pb-free lead plating ; RoHS compliant

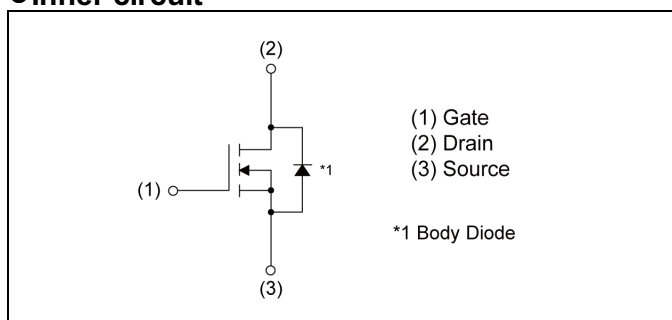
●Application

Switching

●Outline



●Inner circuit



●Packaging specifications

Type	Packing	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	360
	Taping code	C8
	Marking	R6030KNZ

●Absolute maximum ratings ($T_a = 25^\circ\text{C}$, unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V_{DSS}	600	V
Continuous drain current ($T_c = 25^\circ\text{C}$)		I_D^{*1}	±30	A
Pulsed drain current		I_{DP}^{*2}	±90	A
Gate - Source voltage	static	V_{GSS}	±20	V
	AC($f > 1\text{Hz}$)		±30	V
Avalanche current, single pulse		I_{AS}	5.2	A
Avalanche energy, single pulse		E_{AS}^{*3}	636	mJ
Power dissipation ($T_c = 25^\circ\text{C}$)		P_D	86	W
Junction temperature		T_j	150	°C
Operating junction and storage temperature range		T_{stg}	-55 to +150	°C

● Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC}^{*4}	-	-	1.5	°C/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	40	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

● Electrical characteristics ($T_a = 25^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	600	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}\text{C}$	-	-	100	μA
		$T_j = 125^{\circ}\text{C}$	-	-	1000	
Gate - Source leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = 10V, I_D = 1mA$	3	-	5	V
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$V_{GS} = 10V, I_D = 14.5A$ $T_j = 25^{\circ}\text{C}$	-	0.115	0.130	Ω
		$T_j = 125^{\circ}\text{C}$	-	0.26	-	
Gate resistance	R_G	$f = 1\text{MHz, open drain}$	-	2.1	-	Ω

●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Forward Transfer Admittance	$ Y_{fs} ^{*5}$	$V_{DS} = 10\text{V}, I_D = 15\text{A}$	10	20	-	S
Input capacitance	C_{iss}	$V_{GS} = 0\text{V}$	-	2350	-	pF
Output capacitance	C_{oss}	$V_{DS} = 25\text{V}$	-	2000	-	
Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$	-	70	-	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \approx 300\text{V}, V_{GS} = 10\text{V}$	-	35	-	ns
Rise time	t_r^{*5}	$I_D = 15\text{A}$	-	65	-	
Turn - off delay time	$t_{d(off)}^{*5}$	$R_L \approx 20\Omega$	-	100	-	
Fall time	t_f^{*5}	$R_G = 10\Omega$	-	50	-	

●Gate charge characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	Q_g^{*5}	$V_{DD} \approx 300\text{V}$	-	56	-	nC
Gate - Source charge	Q_{gs}^{*5}	$I_D = 30\text{A}$	-	18	-	
Gate - Drain charge	Q_{gd}^{*5}	$V_{GS} = 10\text{V}$	-	23	-	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} \approx 300\text{V}, I_D = 30\text{A}$	-	6.6	-	V

*1 Limited only by maximum channel temperature allowed.

*2 $P_w \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$

*3 $L \approx 50\text{mH}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, STARTING $T_j = 25^\circ\text{C}$

*4 $T_C = 25^\circ\text{C}$

*5 Pulsed

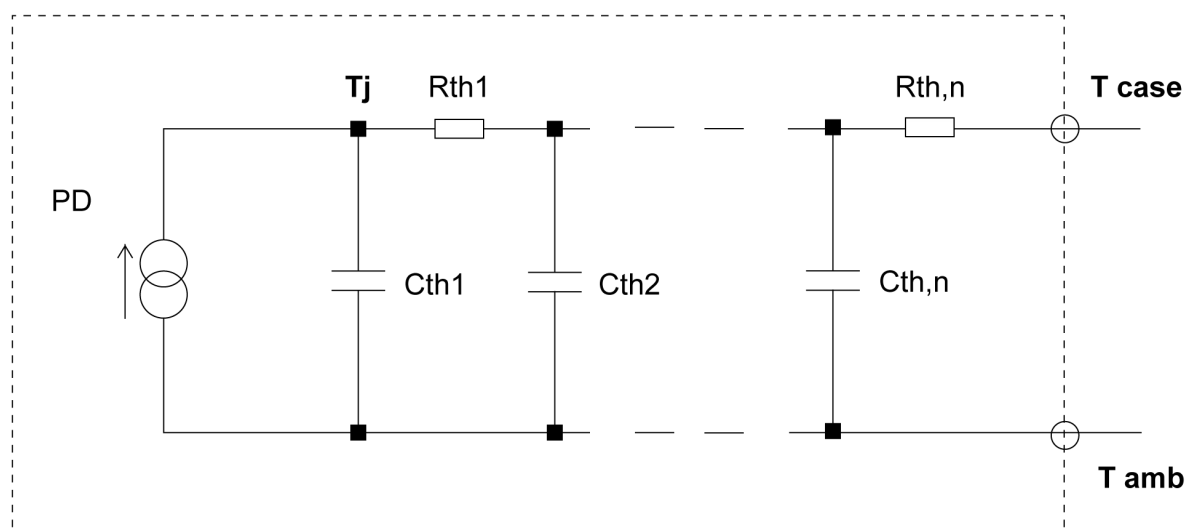
●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Continuous forward current	I_S^{*1}	$T_C = 25^\circ\text{C}$	-	-	30	A
Pulse forward current	I_{SP}^{*2}		-	-	90	A
Forward voltage	V_{SD}^{*5}	$V_{GS} = 0\text{V}, I_S = 30\text{A}$	-	-	1.5	V
Reverse recovery time	t_{rr}^{*5}	$I_S = 30\text{A}$ $di/dt = 100\text{A}/\mu\text{s}$	-	517	-	ns
Reverse recovery charge	Q_{rr}^{*5}		-	9.6	-	μC
Peak reverse recovery current	I_{rm}^{*5}		-	37	-	A

●Typical transient thermal characteristics

Symbol	Value	Unit
R_{th1}	0.0865	K/W
R_{th2}	0.469	
R_{th3}	1.22	

Symbol	Value	Unit
C_{th1}	0.00598	Ws/K
C_{th2}	0.0547	
C_{th3}	1.09	



●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

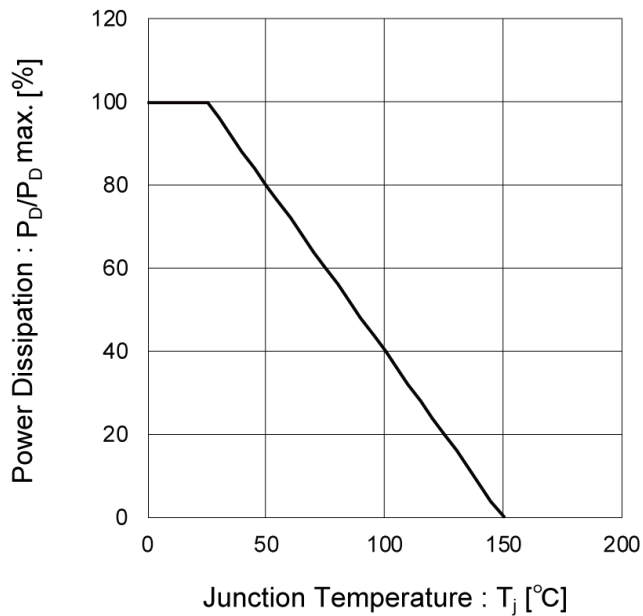


Fig.2 Maximum Safe Operating Area

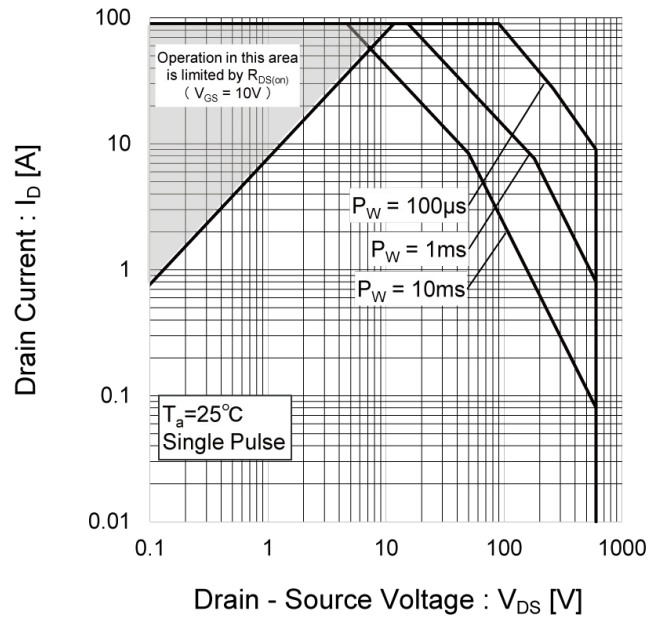
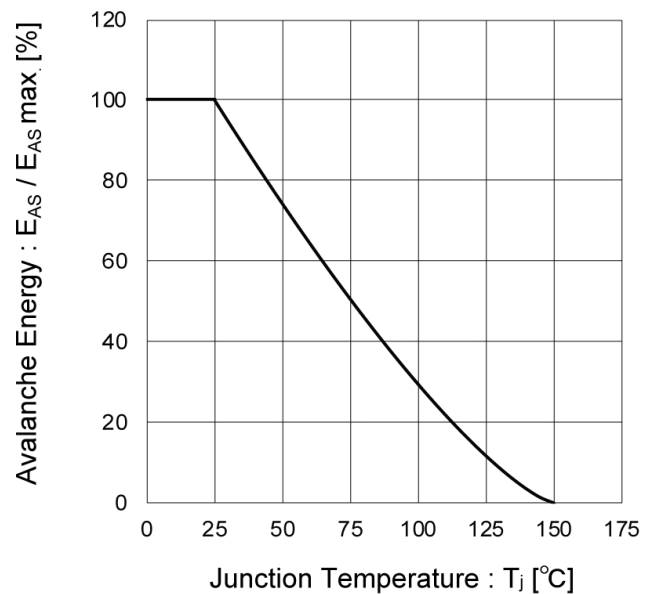


Fig.3 Avalanche Energy Derating Curve vs. Junction Temperature



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

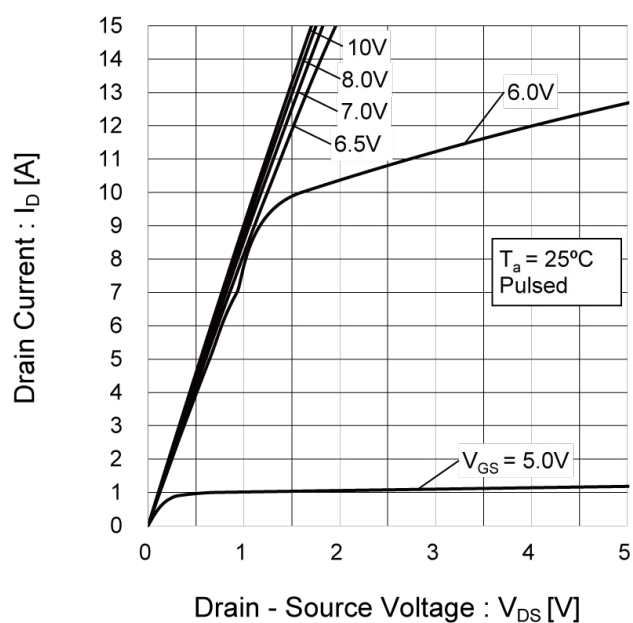
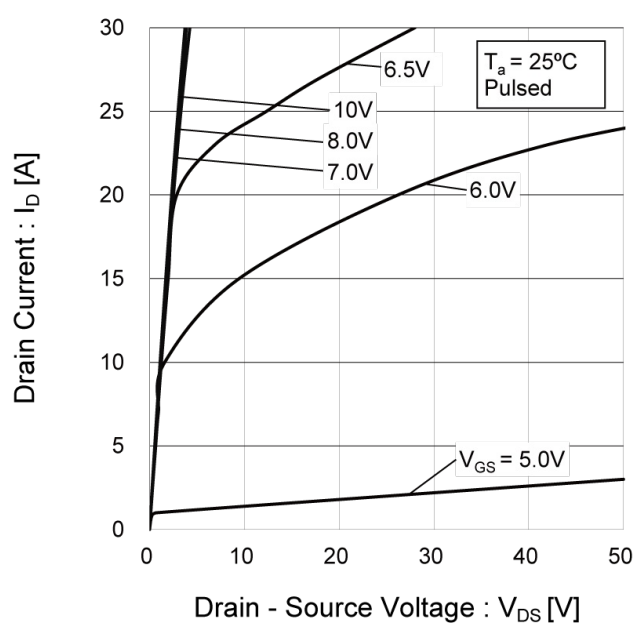


Fig.5 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.6 Breakdown Voltage vs.
Junction Temperature

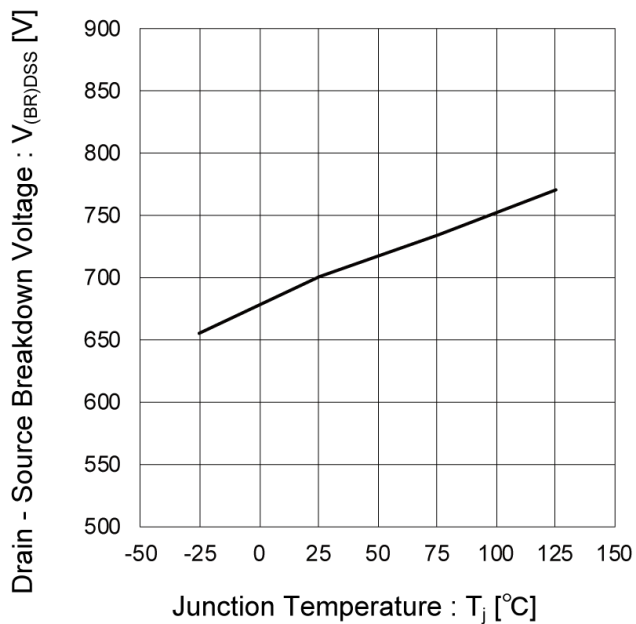


Fig.7 Typical Transfer Characteristics

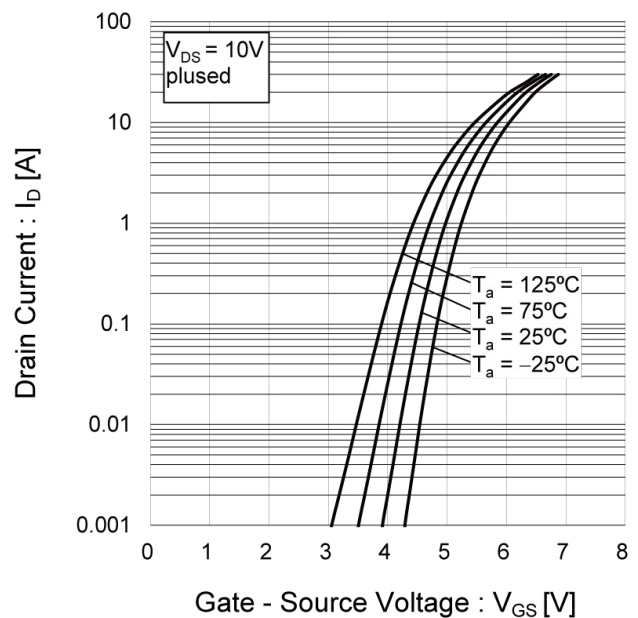


Fig.8 Gate Threshold Voltage vs.
Junction Temperature

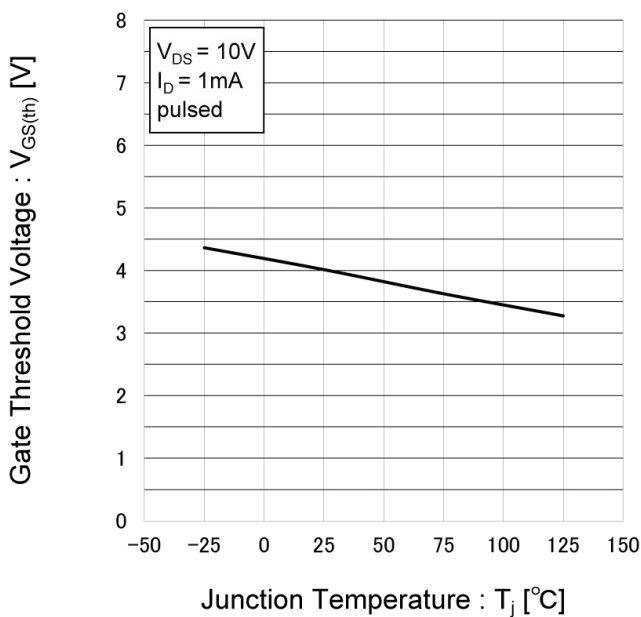
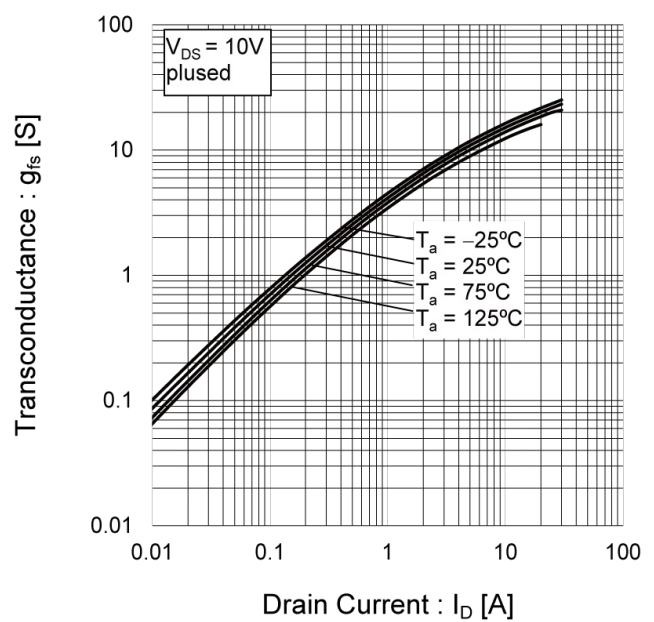


Fig.9 Forward Transfer Admittance vs.
Drain Current



●Electrical characteristic curves

Fig.10 Static Drain - Source On - State Resistance vs. Gate Source Voltage

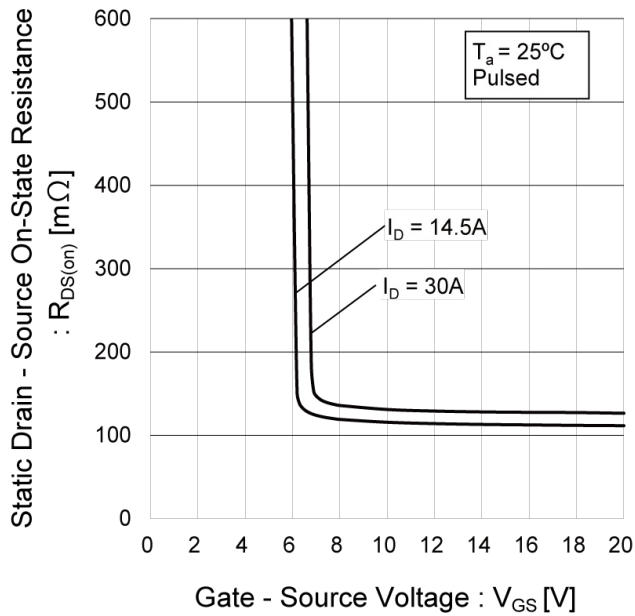


Fig.11 Static Drain - Source On - State Resistance vs. Junction Temperature

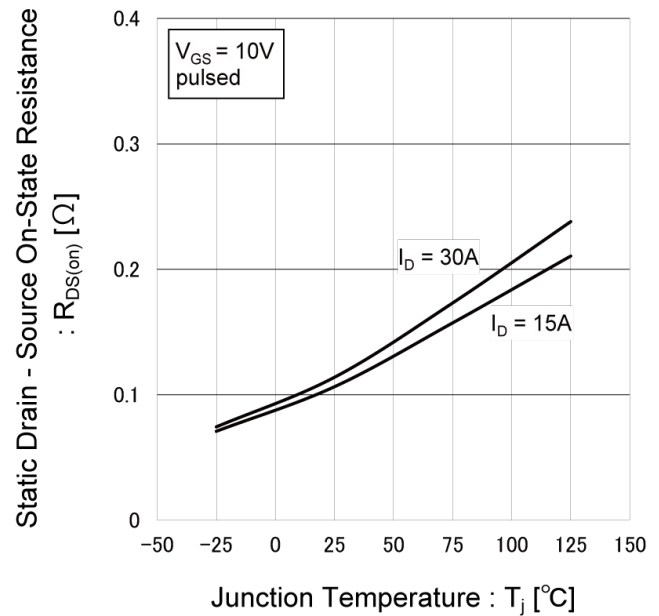
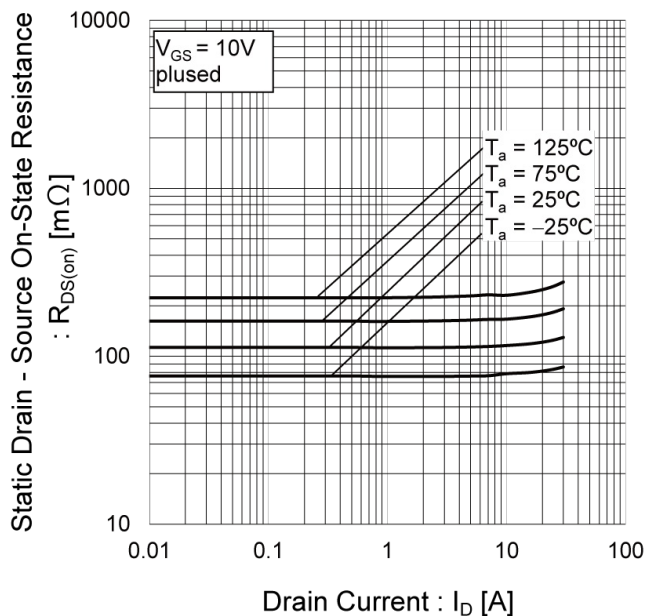


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current(I)



●Electrical characteristic curves

Fig.13 Typical Capacitance vs.
Drain - Source Voltage

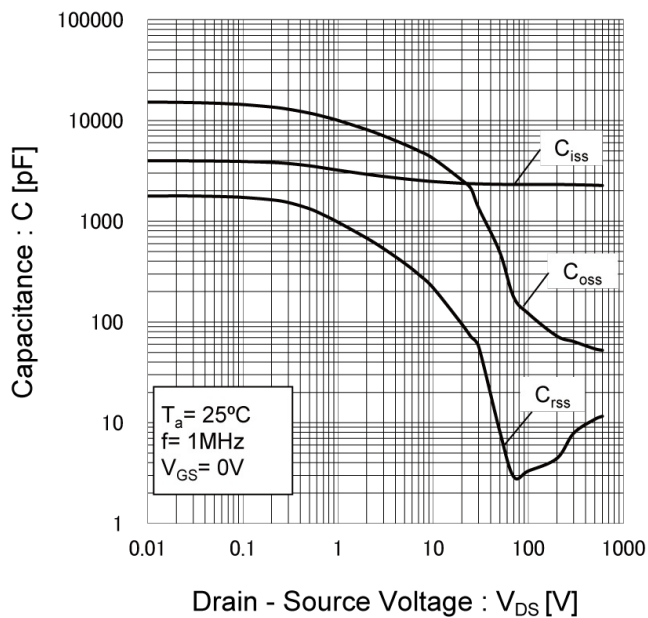


Fig.14 Switching Characteristics

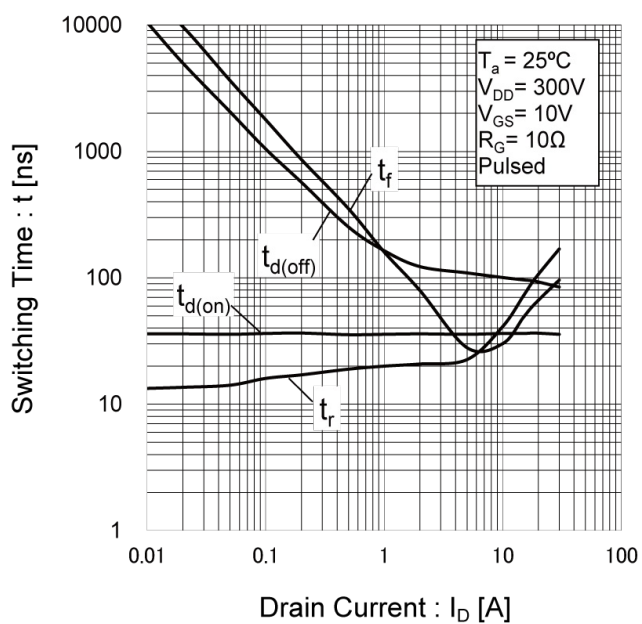
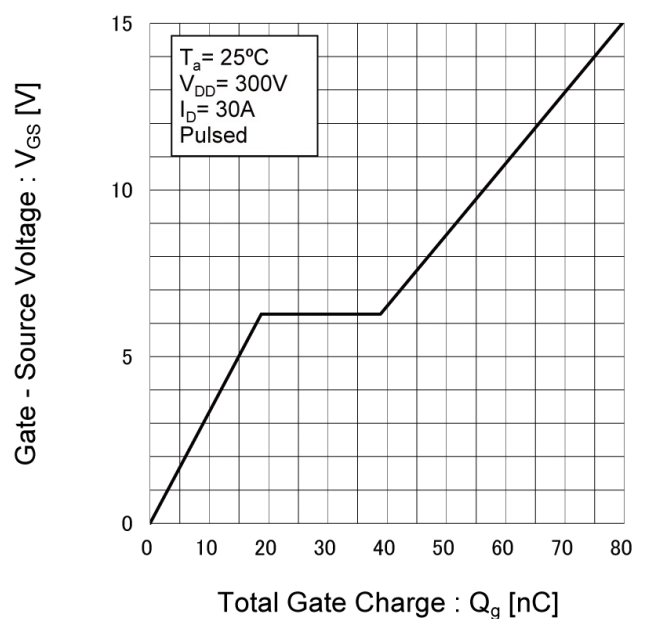


Fig.15 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.16 Inverse Diode Forward Current
vs. Source - Drain Voltage

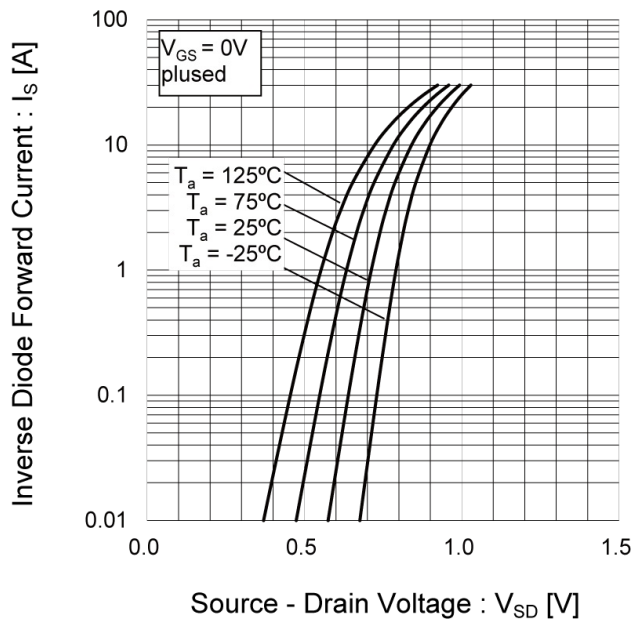
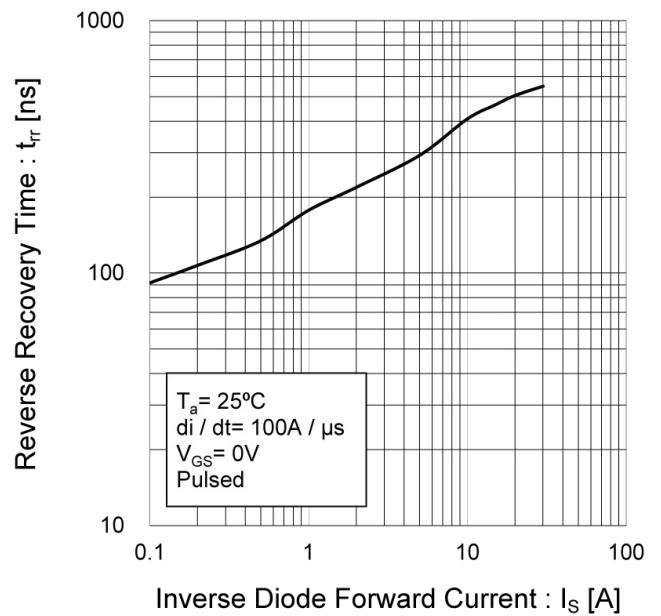


Fig.17 Reverse Recovery Time vs.
Inverse Diode Forward Current



● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

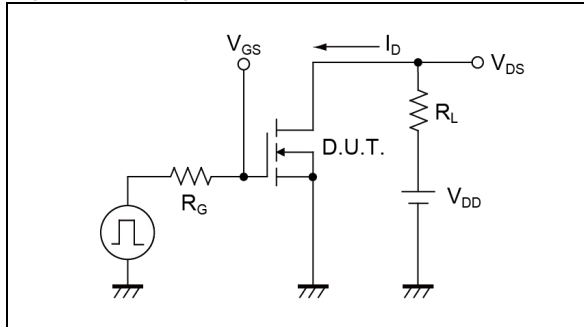


Fig.1-2 Switching Waveforms

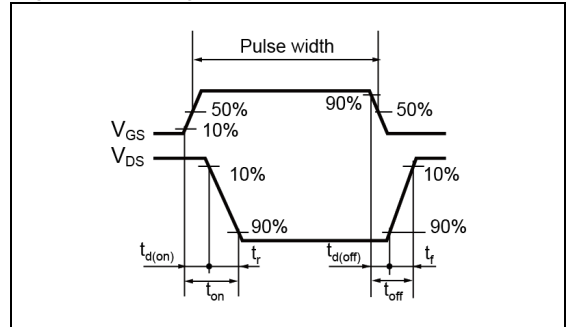


Fig.2-1 Gate Charge Measurement Circuit

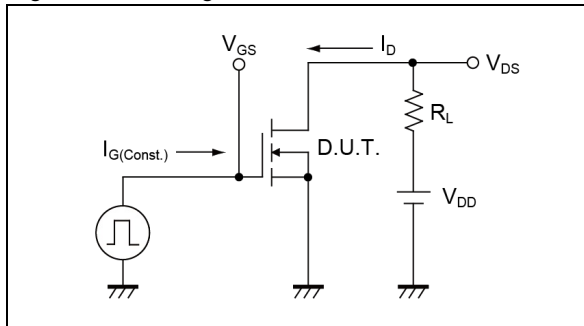


Fig.2-2 Gate Charge Waveform

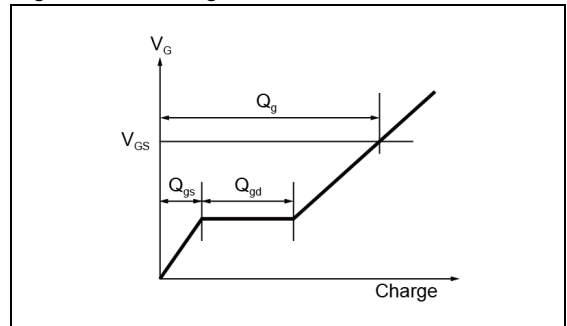


Fig.3-1 Avalanche Measurement Circuit

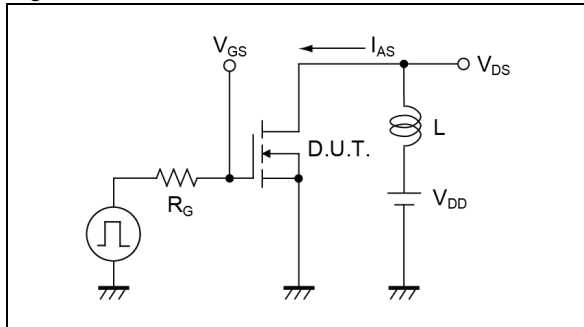


Fig.3-2 Avalanche Waveform

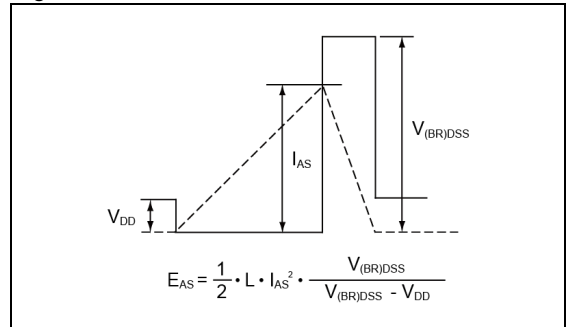


Fig.4-1 dv/dt Measurement Circuit

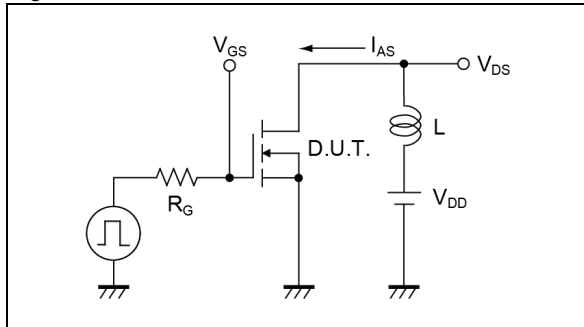


Fig.4-2 dv/dt Waveform

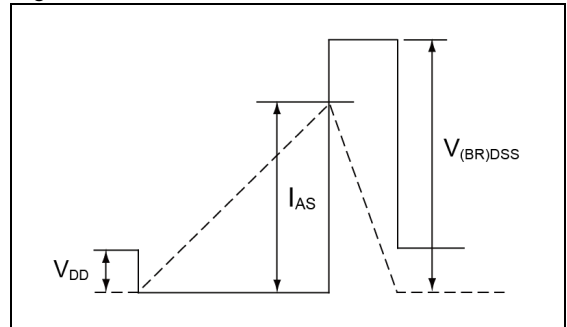


Fig.5-1 dv/dt Measurement Circuit

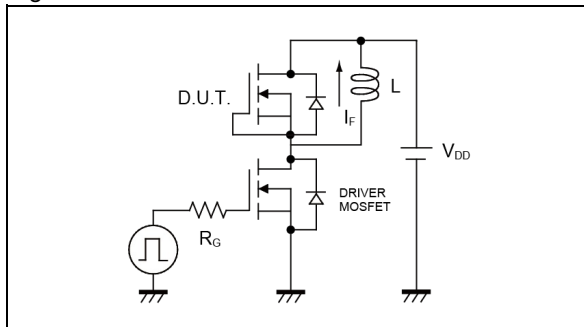
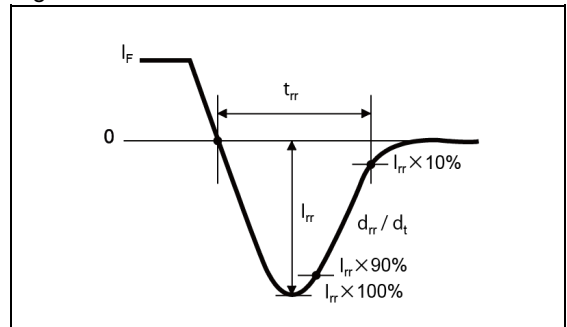
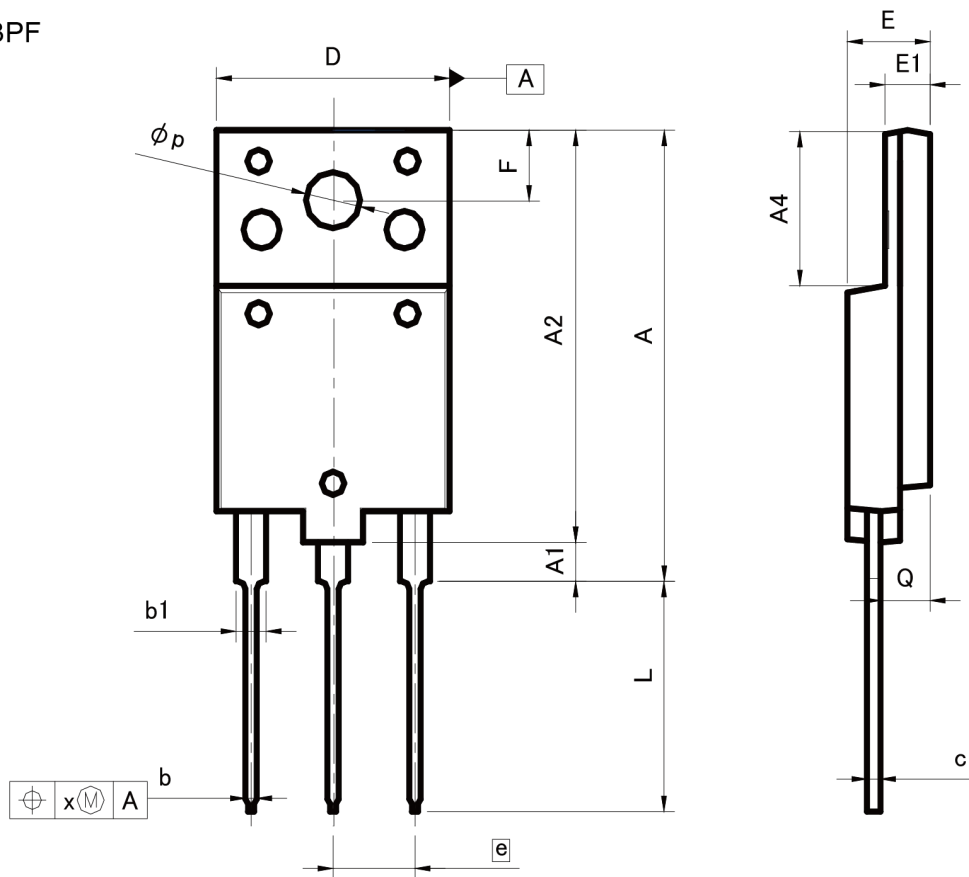


Fig.5-2 dv/dt Waveform



●Dimensions

TO-3PF



DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	26.30	26.70	1.035	1.051
A1	2.30	2.70	0.091	0.106
A2	26.30	26.70	1.035	1.051
A4	9.80	10.20	0.386	0.402
b	0.65	0.95	0.026	0.037
b1	1.80	2.20	0.071	0.087
c	0.80	1.10	0.031	0.043
D	15.30	15.70	0.602	0.618
E	5.30	5.70	0.209	0.224
e	5.45		0.215	—
E1	2.80	3.20	0.110	0.126
F	4.30	4.70	0.169	0.185
L	14.60	15.00	0.575	0.591
p	3.40	3.80	0.134	0.150
Q	3.10	3.50	0.122	0.138
x	—	0.50	—	0.020

Dimension in mm/inches

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